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(12) **United States Design Patent** (10) **Patent No.:** **US D898,170 S**
Yoshida et al. (45) **Date of Patent:** **** Oct. 6, 2020**

(54) **COMPOSITE SEAL MEMBER FOR SEMICONDUCTOR PRODUCTION APPARATUS**

(71) Applicant: **Valqua, Ltd.**, Tokyo (JP)

(72) Inventors: **Nobuhiro Yoshida**, Gojo (JP); **Ippei Nakagawa**, Gojo (JP); **Sangho Kim**, Gojo (JP)

(73) Assignee: **Valqua, Ltd.**, Tokyo (JP)

(**) Term: **15 Years**

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(51) **LOC (12) Cl.** **23-01**

(52) **U.S. Cl.**

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CPC **F16J 15/025** (2013.01)

(58) **Field of Classification Search**

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277/361–364, 381, 606, 616, 314, 382,

277/394, 395; D15/48.2, 122, 164

CPC F16J 15/025; F16J 15/064

See application file for complete search history.

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Primary Examiner — Richard E Chilcot

(74) *Attorney, Agent, or Firm* — The Webb Law Firm

(57) **CLAIM**

The ornamental design for composite seal member for semiconductor production apparatus, as shown and described.

DESCRIPTION

1.1 is a perspective view of a composite seal member for semiconductor production apparatus, showing our new design;

1.2 is a front elevation view thereof;

1.3 is a rear elevation view thereof;

1.4 is a left side elevation view thereof;

1.5 is a right side elevation view thereof;

1.6 is a top view thereof;

1.7 is a bottom view thereof;

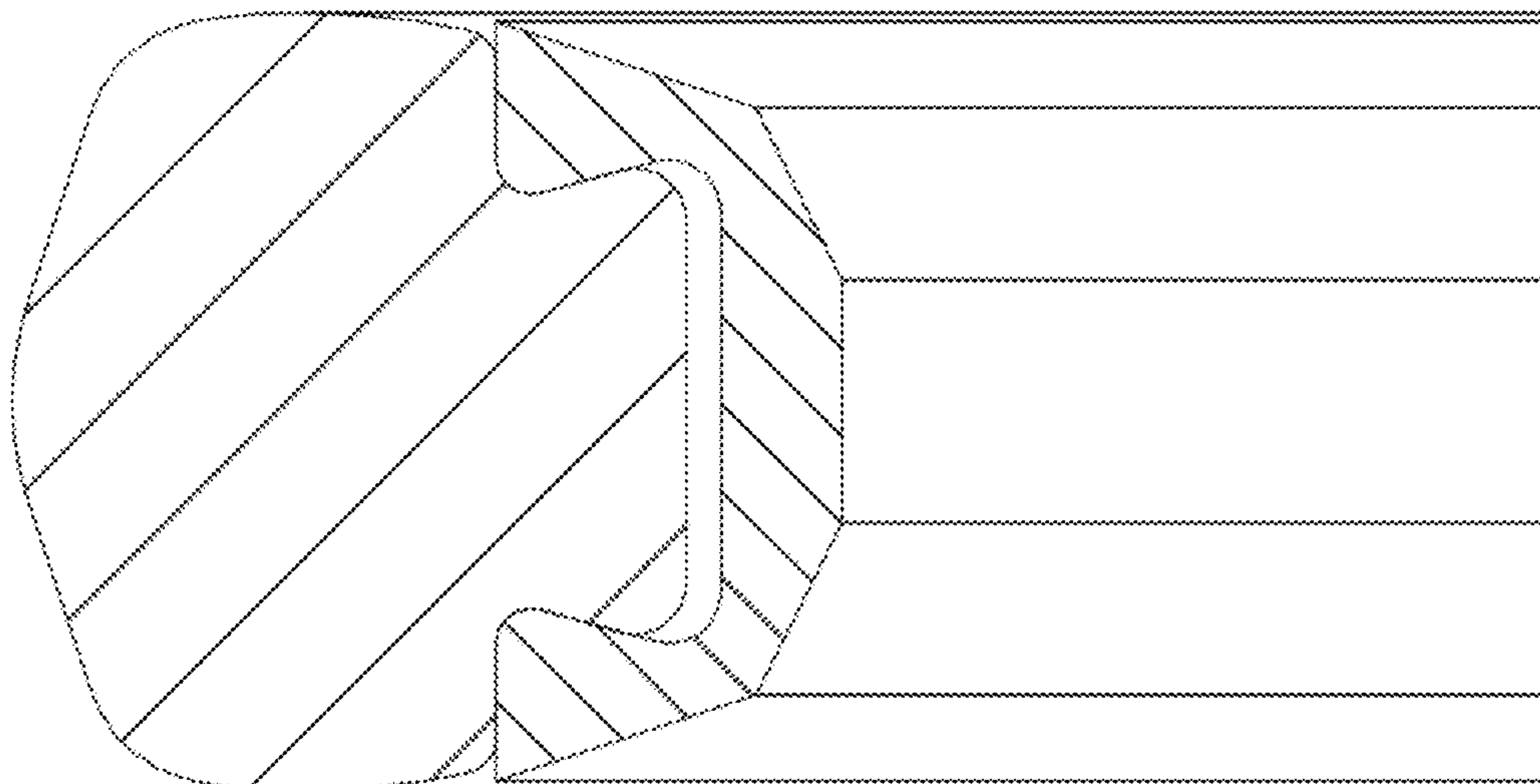
1.8 is a cross-sectional view thereof;

1.9 is an enlarged cross-sectional view of a portion thereof; and

1.10 is an enlarged cross-sectional view of a portion thereof in a condition of use.

The broken lines shown in Reproduction **1.10** are for the purposes of illustrating environmental structure and form no part of the claimed design.

1 Claim, 7 Drawing Sheets



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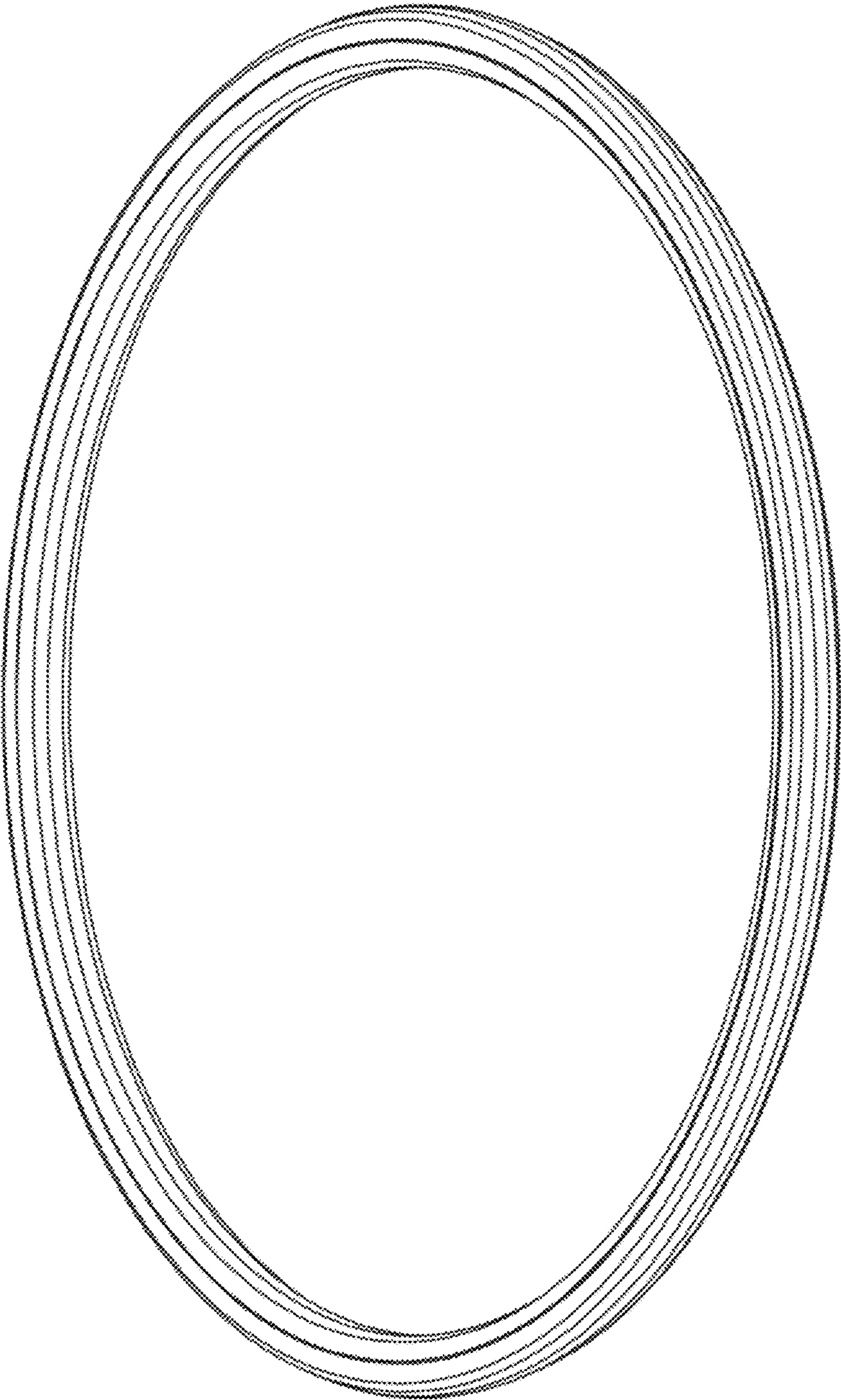
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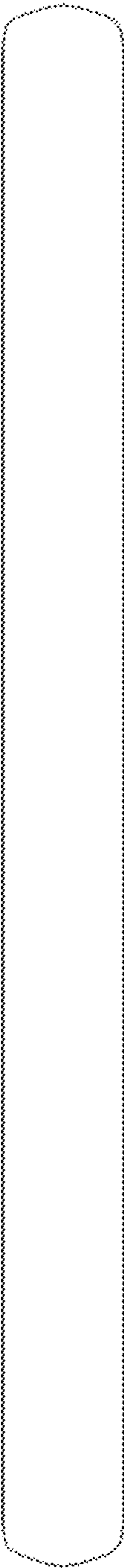
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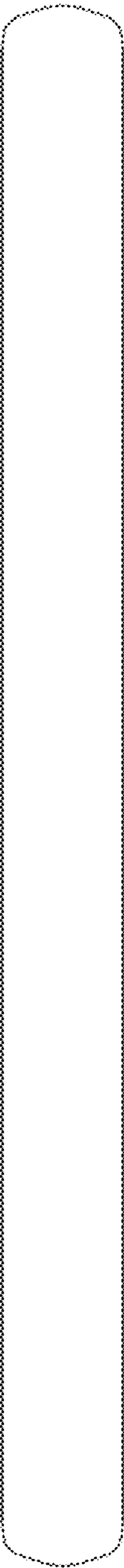
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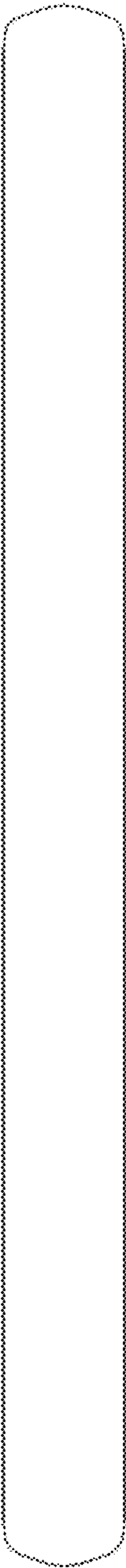
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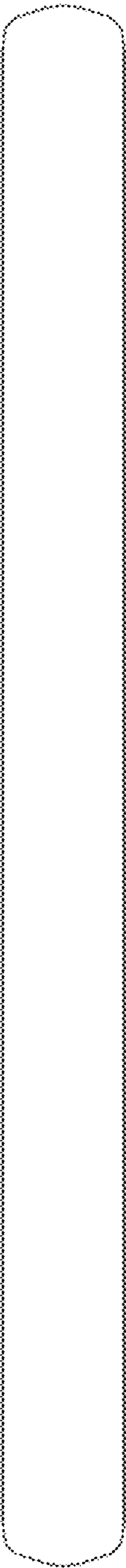
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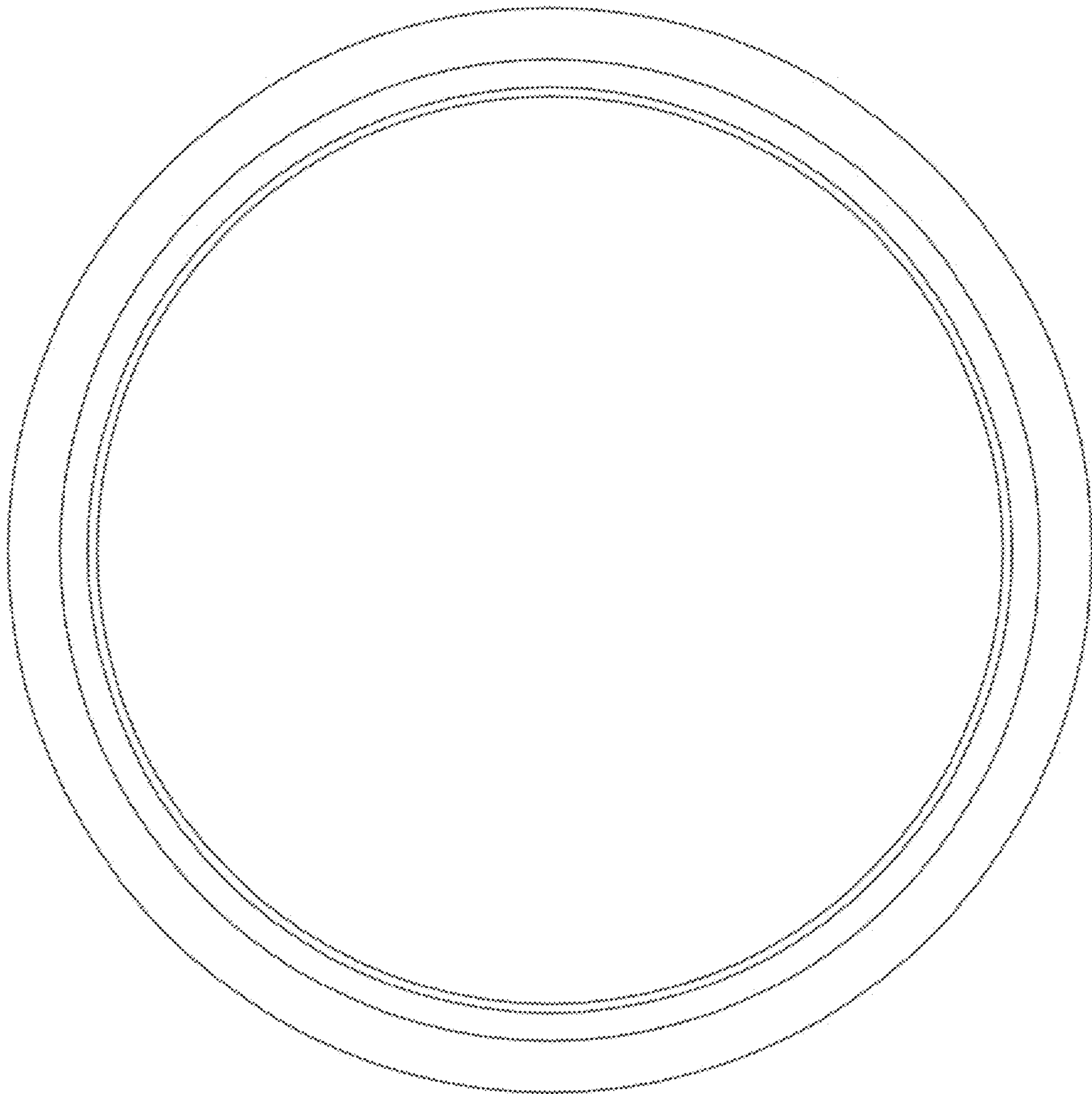


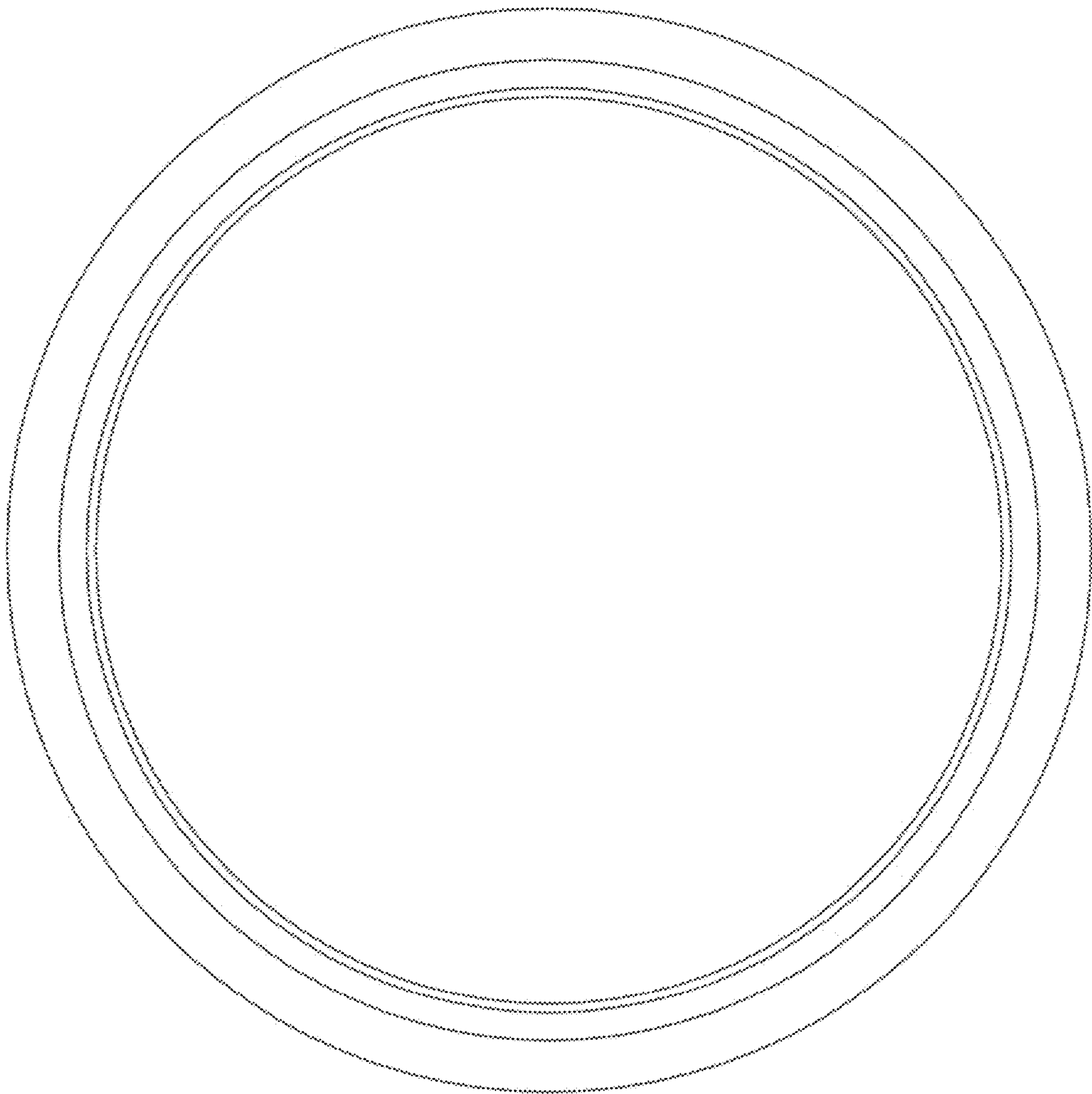
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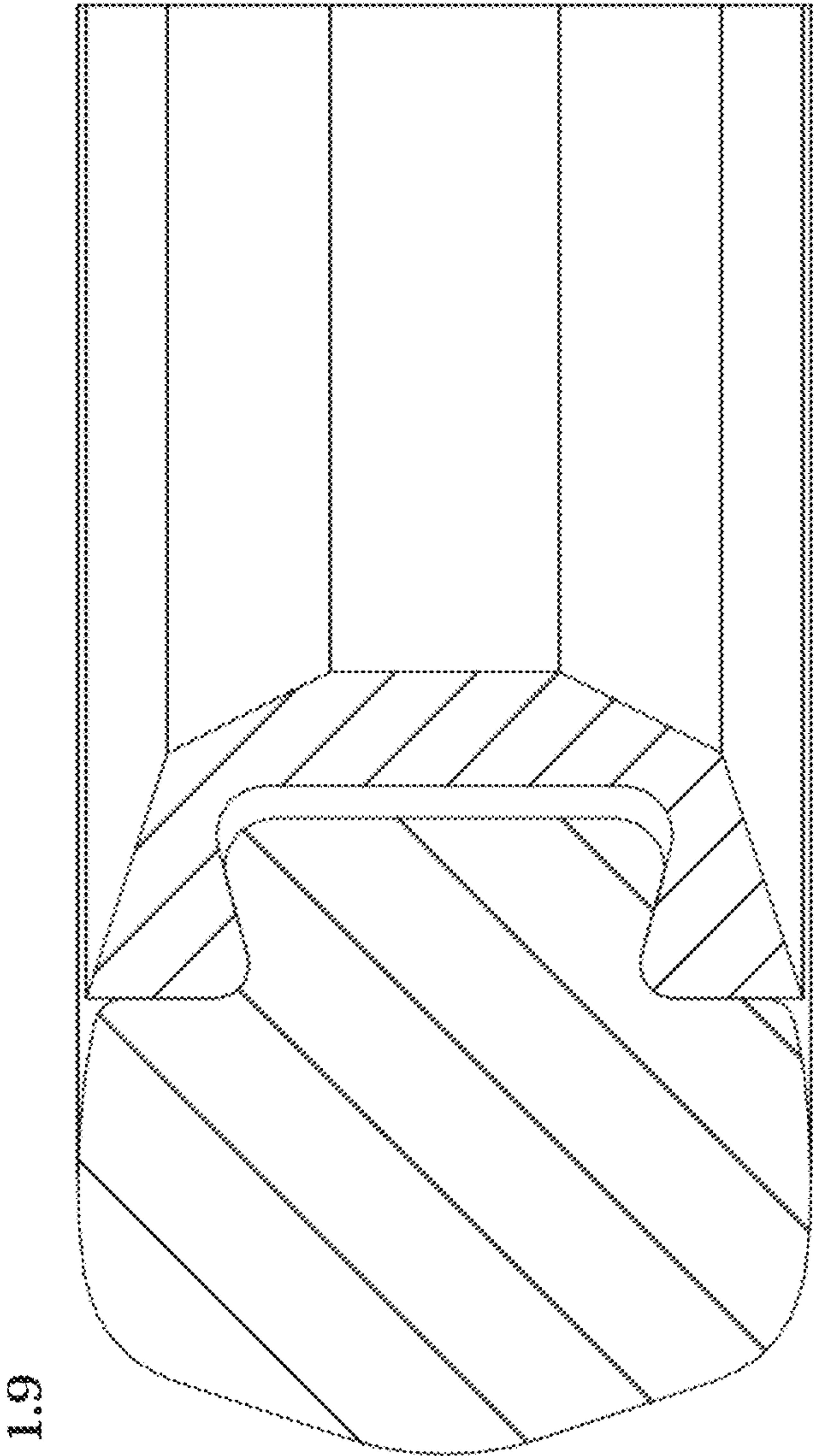
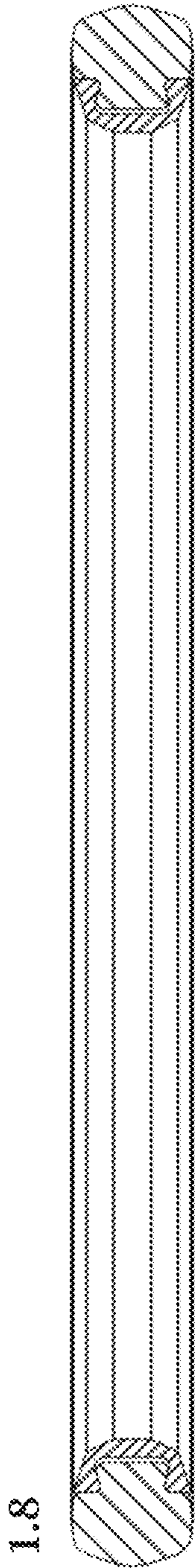


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1.10

